



# PSMN8R0-40PS

N-channel 40 V 7.6 mΩ standard level MOSFET

Rev. 02 — 25 June 2009

Product data sheet

## 1. Product profile

### 1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

### 1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive sources

### 1.3 Applications

- DC-to-DC convertors
- Motor control
- Load switching
- Server power supplies

### 1.4 Quick reference data

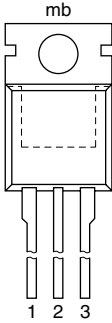
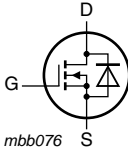
Table 1. Quick reference

| Symbol                         | Parameter                        | Conditions   | Min | Typ | Max | Unit |    |
|--------------------------------|----------------------------------|--|-----|-----|-----|------|----|
| $V_{DS}$                       | drain-source voltage             | $T_j \geq 25\text{ °C}; T_j \leq 175\text{ °C}$  | -   | -   | 40  | V    |    |
| $I_D$                          | drain current                    | $T_{mb} = 25\text{ °C}; V_{GS} = 10\text{ V};$<br>see <a href="#">Figure 1</a>   | -   | -   | 77  | A    |    |
| $P_{tot}$                      | total power dissipation          | $T_{mb} = 25\text{ °C};$ see <a href="#">Figure 2</a>  | -   | -   | 86  | W    |    |
| <b>Dynamic characteristics</b> |                                  |  |     |     |     |      |    |
| $Q_{GD}$                       | gate-drain charge                | $V_{GS} = 10\text{ V}; I_D = 25\text{ A};$<br>$V_{DS} = 20\text{ V};$ see <a href="#">Figure 14</a> ;<br>see <a href="#">Figure 15</a> | -   | 3.8 | -   | nC   |    |
| <b>Static characteristics</b>  |                                  |  |     |     |     |      |    |
| $R_{DS(on)}$                   | drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 25\text{ A};$<br>$T_j = 25\text{ °C};$ see <a href="#">Figure 13</a>                                      | [1] | -   | 6.2 | 7.6  | mΩ |

[1] Measured 3 mm from package.

## 2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description                       | Simplified outline   | Graphic symbol  |
|-----|--------|-----------------------------------|--|---|
| 1   | G      | gate                              |  <p style="text-align: center;"><b>SOT78</b><br/><b>(TO-220AB)</b></p> |  |
| 2   | D      | drain                             |  |   |
| 3   | S      | source                            |  |   |
| mb  | D      | mounting base; connected to drain |  |   |

## 3. Ordering information

Table 3. Ordering information

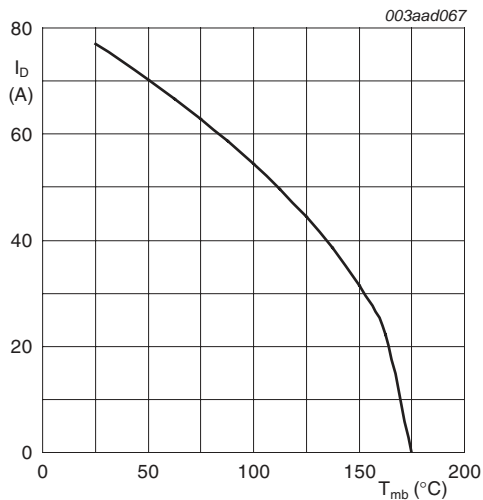
| Type number  | Package  |  | Version |
|--------------|----------|--|---------|
|              | Name     | Description  |         |
| PSMN8R0-40PS | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78   |

## 4. Limiting values

**Table 4. Limiting values**

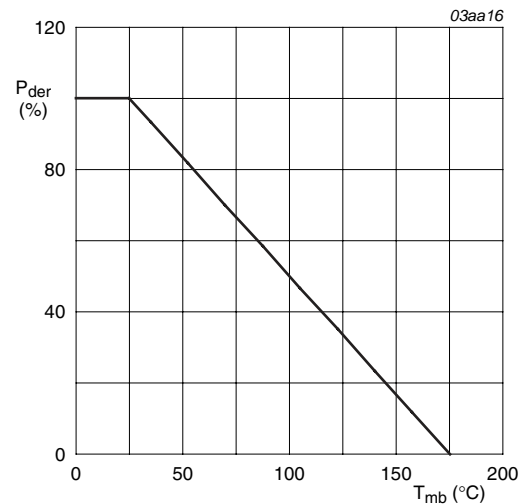
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                      | Parameter                                    | Conditions   | Min | Max | Unit |
|-----------------------------|--|--|-----|-----|------|
| $V_{DS}$                    | drain-source voltage                         | $T_j \geq 25\text{ °C}$ ; $T_j \leq 175\text{ °C}$   | -   | 40  | V    |
| $V_{DGR}$                   | drain-gate voltage                           | $T_j \geq 25\text{ °C}$ ; $T_j \leq 175\text{ °C}$ ; $R_{GS} = 20\text{ k}\Omega$  | -   | 40  | V    |
| $V_{GS}$                    | gate-source voltage                          |  | -20 | 20  | V    |
| $I_D$                       | drain current                                | $V_{GS} = 10\text{ V}$ ; $T_{mb} = 100\text{ °C}$ ; see <a href="#">Figure 1</a>   | -   | 55  | A    |
|                             |  | $V_{GS} = 10\text{ V}$ ; $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 1</a>  | -   | 77  | A    |
| $I_{DM}$                    | peak drain current                           | $t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 3</a>  | -   | 309 | A    |
| $P_{tot}$                   | total power dissipation                      | $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 2</a>   | -   | 86  | W    |
| $T_{stg}$                   | storage temperature                          |  | -55 | 175 | °C   |
| $T_j$                       | junction temperature                         |  | -55 | 175 | °C   |
| <b>Source-drain diode</b>   |  |  |     |     |      |
| $I_S$                       | source current                               | $T_{mb} = 25\text{ °C}$  | -   | 77  | A    |
| $I_{SM}$                    | peak source current                          | $t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; $T_{mb} = 25\text{ °C}$   | -   | 309 | A    |
| <b>Avalanche ruggedness</b> |  |  |     |     |      |
| $E_{DS(AL)S}$               | non-repetitive drain-source avalanche energy | $V_{GS} = 10\text{ V}$ ; $T_{j(\text{init})} = 25\text{ °C}$ ; $I_D = 77\text{ A}$ ; $V_{sup} \leq 40\text{ V}$ ; unclamped; $R_{GS} = 50\text{ }\Omega$ | -   | 43  | mJ   |



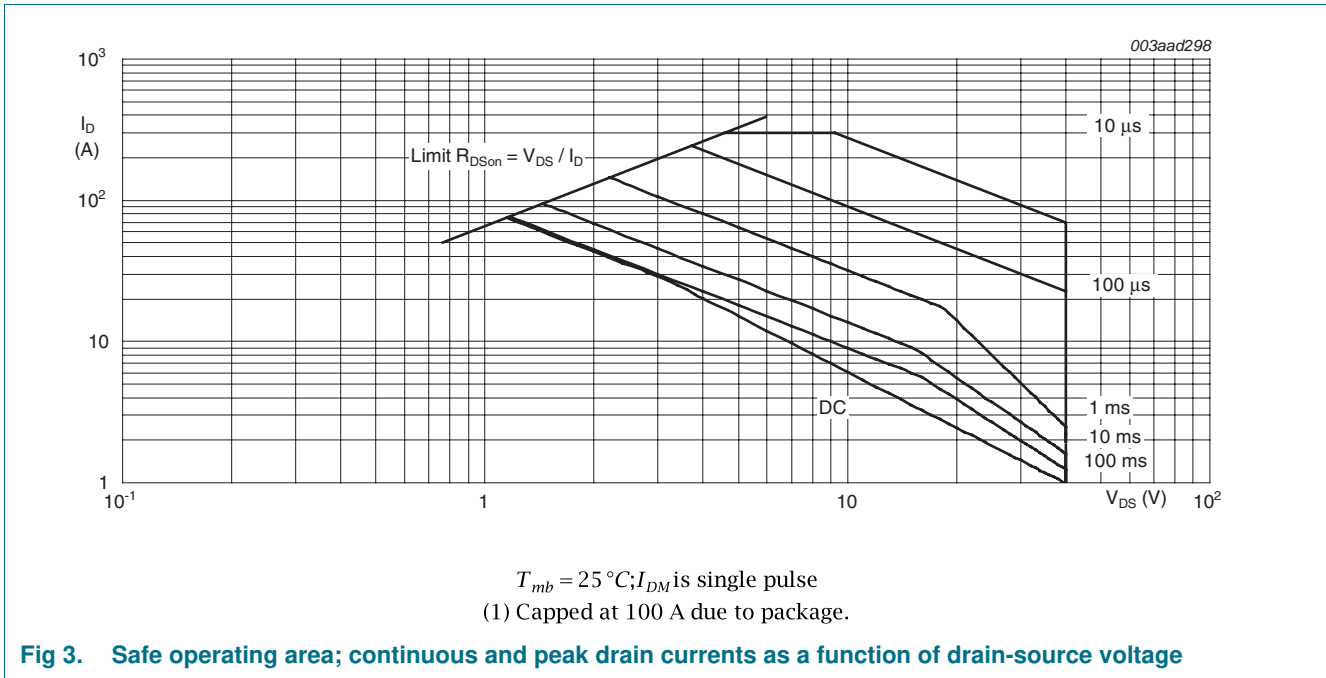
$$V_{GS} \geq 10\text{ V}$$

**Fig 1. Continuous drain current as a function of mounting base temperature**



$$P_{der} = \frac{P_{tot}}{P_{tot(25\text{ °C})}} \times 100\%$$

**Fig 2. Normalized total power dissipation as a function of mounting base temperature**

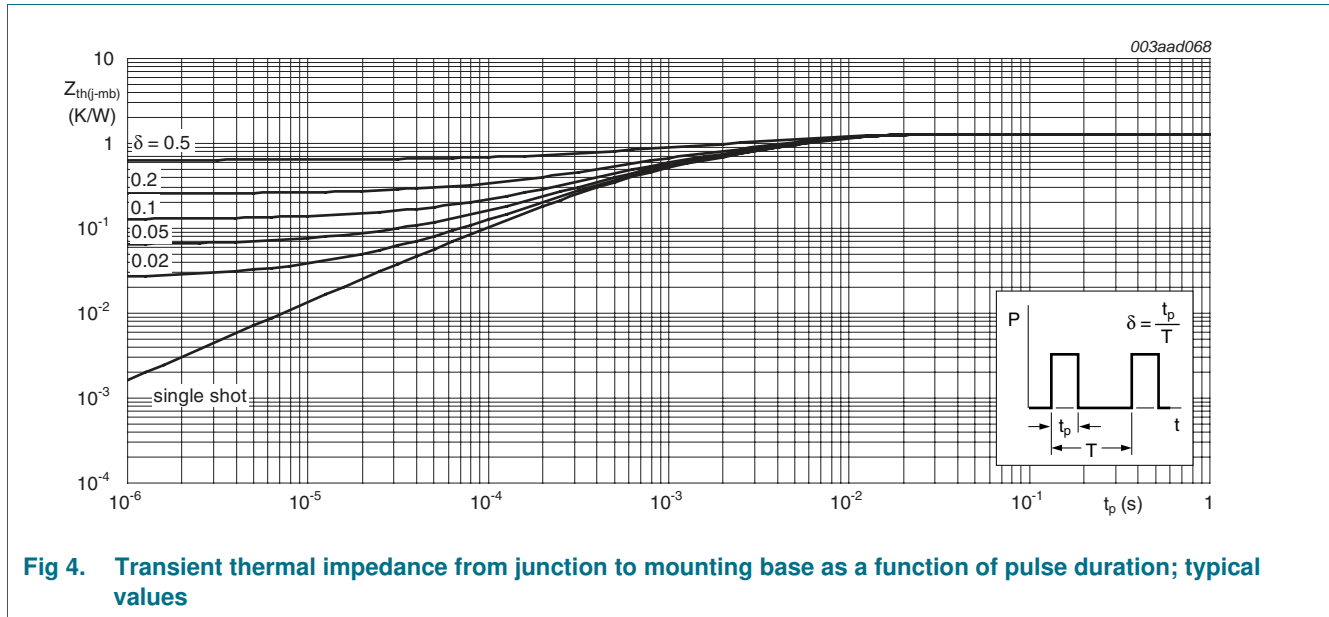


**Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage**

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

| Symbol         | Parameter   | Conditions                   | Min | Typ | Max  | Unit |
|----------------|---|------------------------------|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see <a href="#">Figure 4</a> | -   | 1.2 | 1.74 | K/W  |



**Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values**

## 6. Characteristics

**Table 6. Characteristics**

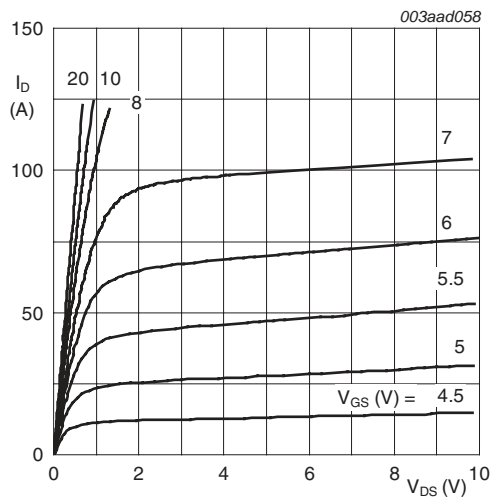
| Symbol                         | Parameter                         | Conditions  | Min | Typ  | Max | Unit          |
|--------------------------------|-----------------------------------|---|-----|------|-----|---------------|
| <b>Static characteristics</b>  |                                   |   |     |      |     |               |
| $V_{(BR)DSS}$                  | drain-source breakdown voltage    | $I_D = 250 \mu\text{A}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ }^\circ\text{C}$   | 36  | -    | -   | V             |
|                                |                                   | $I_D = 250 \mu\text{A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | 40  | -    | -   | V             |
| $V_{GS(th)}$                   | gate-source threshold voltage     | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 11</a> ; see <a href="#">Figure 12</a> | -   | -    | 4.6 | V             |
|                                |                                   | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 11</a> ; see <a href="#">Figure 12</a> | 1   | -    | -   | V             |
|                                |                                   | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 11</a> ; see <a href="#">Figure 12</a>  | 2   | 3    | 4   | V             |
| $I_{DSS}$                      | drain leakage current             | $V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | -   | -    | 1.5 | $\mu\text{A}$ |
|                                |                                   | $V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$   | -   | -    | 30  | $\mu\text{A}$ |
| $I_{GSS}$                      | gate leakage current              | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | -   | -    | 100 | nA            |
|                                |                                   | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$   | -   | -    | 100 | nA            |
| $R_{DS(on)}$                   | drain-source on-state resistance  | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 100 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 13</a>                           | -   | -    | 11  | mΩ            |
|                                |                                   | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 25 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 13</a>                            | [2] | 6.2  | 7.6 | mΩ            |
| $R_G$                          | internal gate resistance (AC)     | $f = 1 \text{ MHz}$   | -   | 1.1  | -   | Ω             |
| <b>Dynamic characteristics</b> |                                   |   |     |      |     |               |
| $Q_{G(tot)}$                   | total gate charge                 | $I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$  | -   | 17   | -   | nC            |
|                                |                                   | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$<br>see <a href="#">Figure 14</a> ; see <a href="#">Figure 15</a>      | -   | 21   | -   | nC            |
| $Q_{GS}$                       | gate-source charge                | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$<br>see <a href="#">Figure 14</a> ; see <a href="#">Figure 15</a>      | -   | 7.2  | -   | nC            |
| $Q_{GS(th)}$                   | pre-threshold gate-source charge  | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$<br>see <a href="#">Figure 14</a>                                      | -   | 3.6  | -   | nC            |
| $Q_{GS(th-pl)}$                | post-threshold gate-source charge |   | -   | 3.6  | -   | nC            |
| $Q_{GD}$                       | gate-drain charge                 | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$<br>see <a href="#">Figure 14</a> ; see <a href="#">Figure 15</a>      | -   | 3.8  | -   | nC            |
| $V_{GS(pl)}$                   | gate-source plateau voltage       | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V};$ see <a href="#">Figure 14</a>  | -   | 4.8  | -   | V             |
| $C_{iss}$                      | input capacitance                 | $V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$<br>$T_j = 25 \text{ }^\circ\text{C};$ see <a href="#">Figure 16</a>     | -   | 1262 | -   | pF            |
| $C_{oss}$                      | output capacitance                |   | -   | 327  | -   | pF            |
| $C_{rss}$                      | reverse transfer capacitance      |   | -   | 160  | -   | pF            |
| $t_{d(on)}$                    | turn-on delay time                | $V_{DS} = 12 \text{ V}; R_L = 0.5 \text{ } \Omega; V_{GS} = 10 \text{ V};$<br>$R_{G(ext)} = 4.7 \text{ } \Omega$                          | -   | 12   | -   | ns            |
| $t_r$                          | rise time                         |   | -   | 4.7  | -   | ns            |
| $t_{d(off)}$                   | turn-off delay time               |   | -   | 21   | -   | ns            |
| $t_f$                          | fall time                         |   | -   | 4.7  | -   | ns            |

Table 6. Characteristics ...continued

| Symbol                    | Parameter             | Conditions   | Min | Typ  | Max | Unit |
|---------------------------|-----------------------|--|-----|------|-----|------|
| <b>Source-drain diode</b> |                       |  |     |      |     |      |
| $V_{SD}$                  | source-drain voltage  | $I_S = 25\text{ A}$ ; $V_{GS} = 0\text{ V}$ ; $T_j = 25\text{ °C}$ ;<br>see <a href="#">Figure 17</a>                                  | -   | 0.85 | 1.2 | V    |
| $t_{rr}$                  | reverse recovery time | $I_S = 50\text{ A}$ ; $di_S/dt = -100\text{ A}/\mu\text{s}$ ; $V_{GS} = 0\text{ V}$ ;<br>$V_{DS} = 20\text{ V}$                        | -   | 30   | -   | ns   |
| $Q_r$                     | recovered charge      | $I_S = 50\text{ A}$ ; $di_S/dt = -100\text{ A}/\mu\text{s}$ ; $V_{GS} = 0\text{ V}$ ;<br>$V_{DS} = 20\text{ V}$ ; $T_j = 25\text{ °C}$ | -   | 18   | -   | nC   |

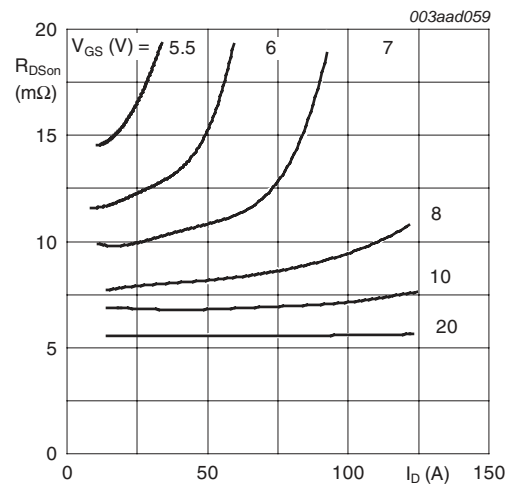
[1] Tested to JEDEC standards where applicable.

[2] Measured 3 mm from package.



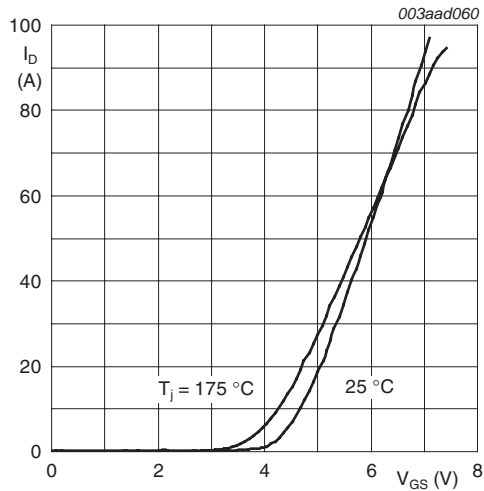
$T_j = 25\text{ °C}$ ;  $t_p = 300\mu\text{s}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



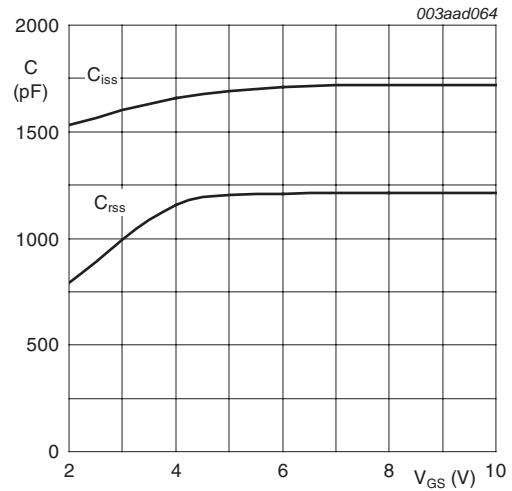
$T_j = 25\text{ °C}$ ;  $t_p = 300\mu\text{s}$

Fig 6. Drain-source on-state resistance as a function of drain current; typical values



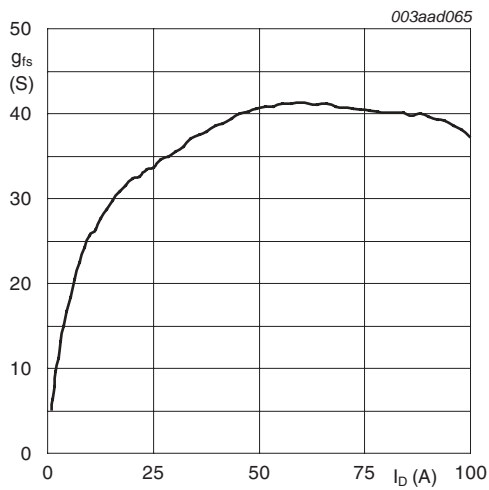
$V_{DS} = 15\text{V}$

Fig 7. Transfer characteristics: drain current as a function of gate-source voltage; typical values



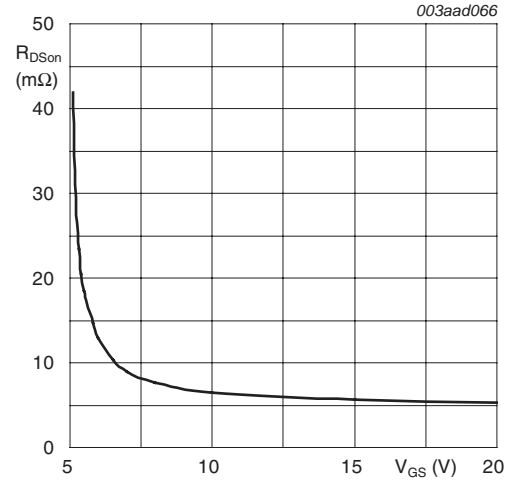
$V_{DS} = 0\text{V}; f = 1\text{MHz}$

Fig 8. Input and reverse transfer capacitances as a function of gate-source voltage; typical values



$T_j = 25^\circ\text{C}; V_{DS} = 15\text{V}$

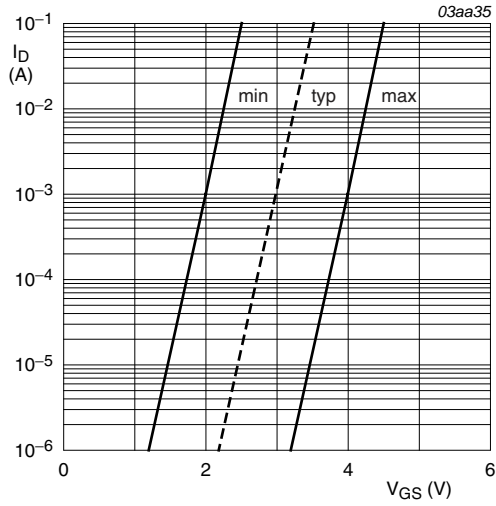
Fig 9. Forward transconductance as a function of drain current; typical values



$T_j = 25^\circ\text{C}; I_D = 25\text{A}$

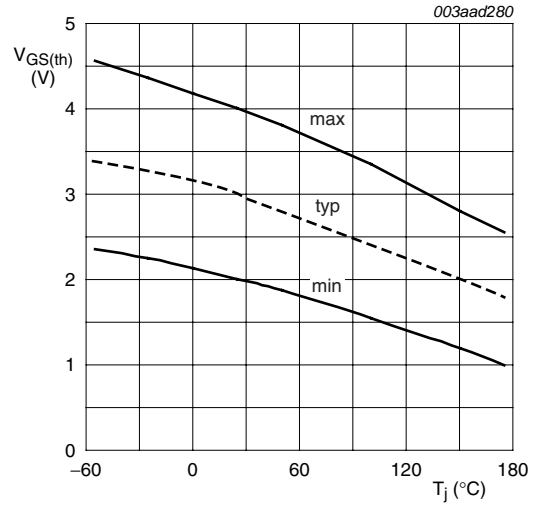
Fig 10. Drain-source on-state resistance as a function of gate-source voltage; typical values





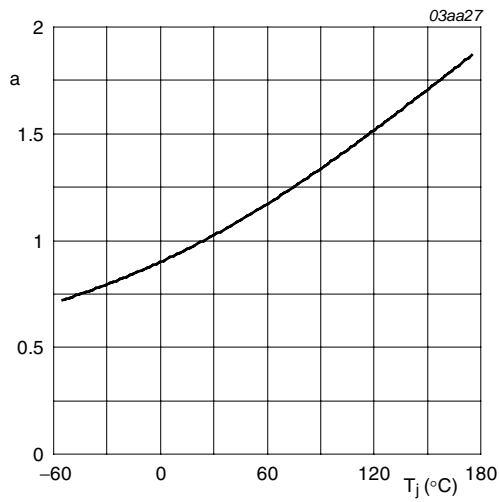
$T_j = 25^\circ\text{C}; V_{DS} = 5\text{V}$

Fig 11. Sub-threshold drain current as a function of gate-source voltage



$I_D = 1\text{mA}; V_{DS} = V_{GS}$

Fig 12. Gate-source threshold voltage as a function of junction temperature



$$a = \frac{R_{DSon}}{R_{DSon(25^\circ\text{C})}}$$

Fig 13. Normalized drain-source on-state resistance factor as a function of junction temperature

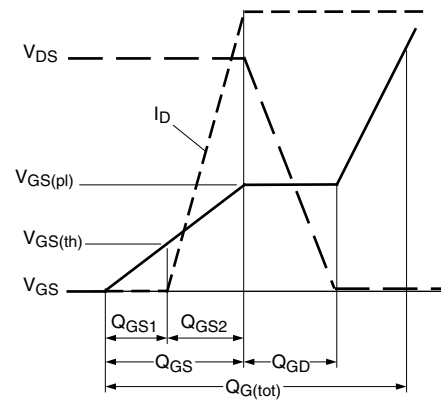
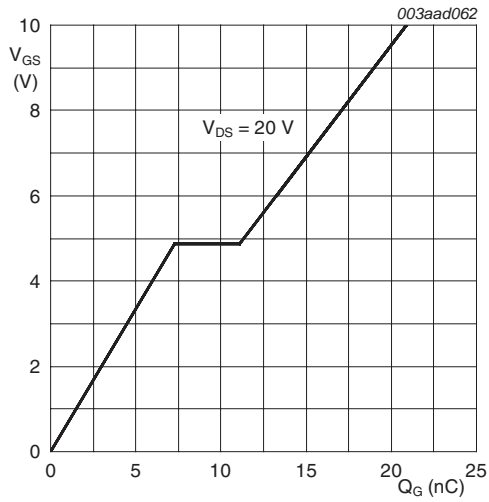
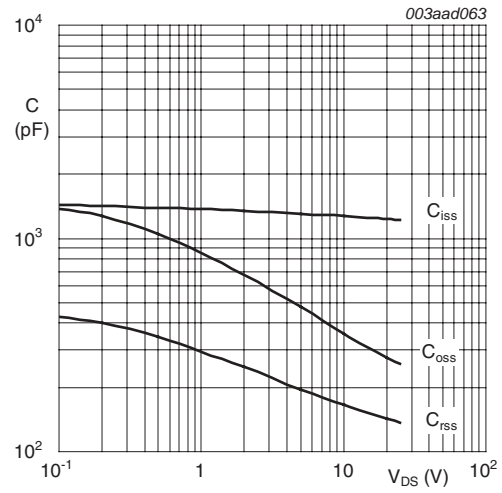


Fig 14. Gate charge waveform definitions



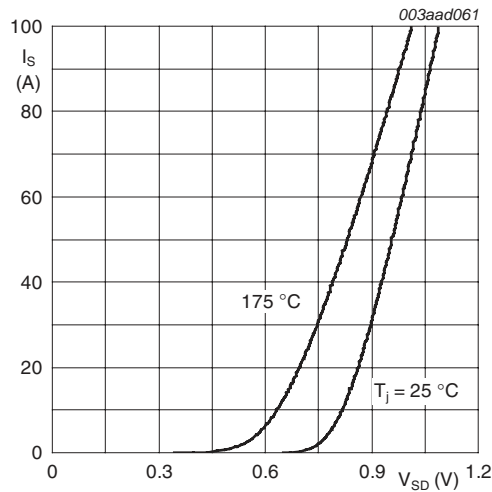
$T_j = 25\text{ }^\circ\text{C}; I_D = 25\text{ A}$

Fig 15. Gate-source voltage as a function of gate charge; typical values



$V_{GS} = 0\text{ V}; f = 1\text{ MHz}$

Fig 16. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{GS} = 0\text{ V}$

Fig 17. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

## 7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78

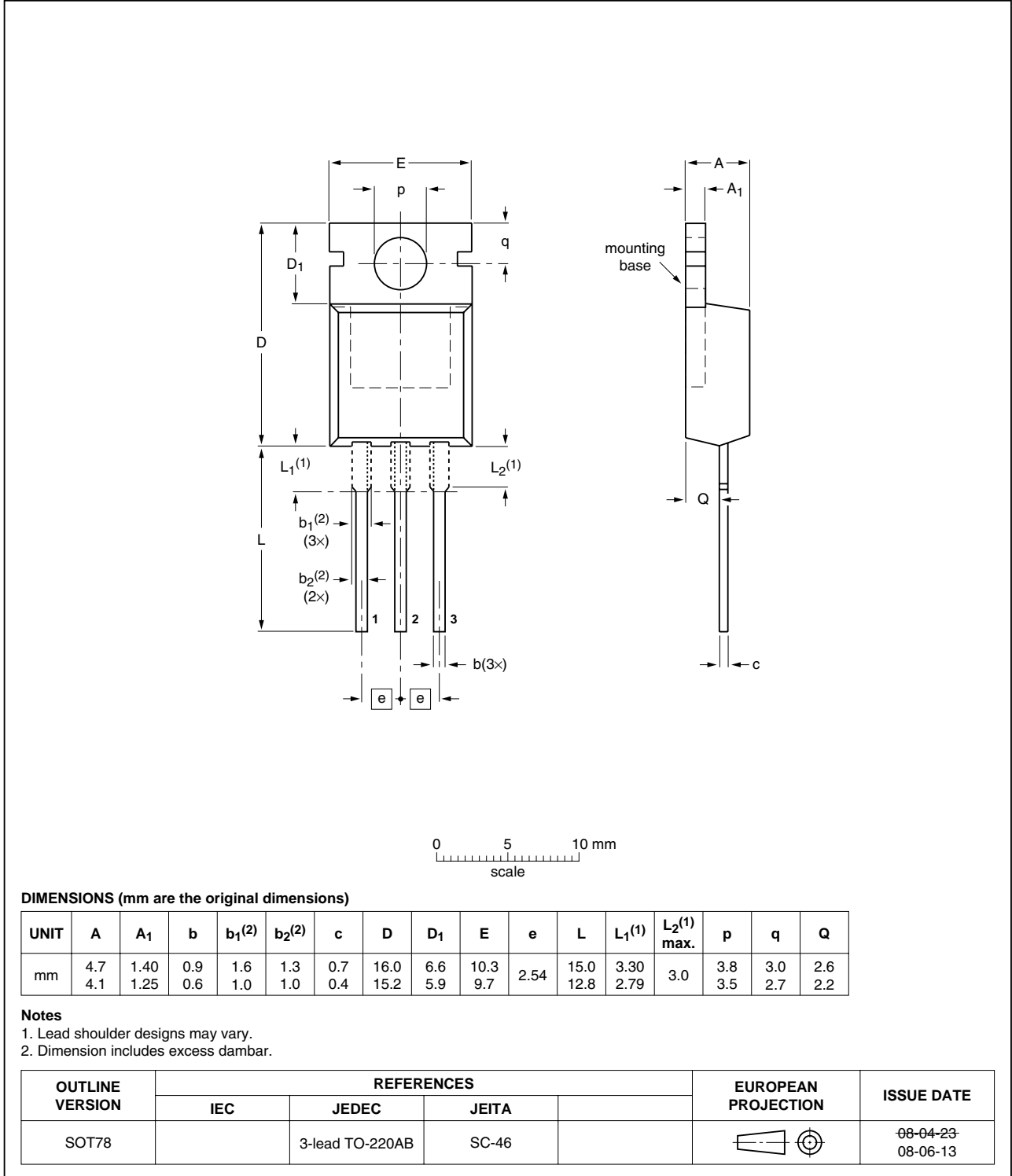


Fig 18. Package outline SOT78 (TO-220AB)

## 8. Revision history

Table 7. Revision history

| Document ID    | Release date                               | Data sheet status    | Change notice | Supersedes     |
|----------------|--|----------------------|---------------|----------------|
| PSMN8R0-40PS_2 | 20090625                                   | Product data sheet   | -             | PSMN8R0-40PS_1 |
| Modifications: | • Status changed from objective to product |                      |               |                |
| PSMN8R0-40PS_1 | 20090511                                   | Objective data sheet | -             | -              |

## 9. Legal information

### 9.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

### 9.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 9.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — Nexperia products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Terms and conditions of sale** — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by Nexperia. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

### 9.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 10. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

## 11. Contents

---

|           |  |           |
|-----------|--|-----------|
| <b>1</b>  | <b>Product profile</b> . . . . .         | <b>1</b>  |
| 1.1       | General description . . . . .            | 1         |
| 1.2       | Features and benefits . . . . .          | 1         |
| 1.3       | Applications . . . . .                   | 1         |
| 1.4       | Quick reference data . . . . .           | 1         |
| <b>2</b>  | <b>Pinning information</b> . . . . .     | <b>2</b>  |
| <b>3</b>  | <b>Ordering information</b> . . . . .    | <b>2</b>  |
| <b>4</b>  | <b>Limiting values</b> . . . . .         | <b>3</b>  |
| <b>5</b>  | <b>Thermal characteristics</b> . . . . . | <b>5</b>  |
| <b>6</b>  | <b>Characteristics</b> . . . . .         | <b>6</b>  |
| <b>7</b>  | <b>Package outline</b> . . . . .         | <b>11</b> |
| <b>8</b>  | <b>Revision history</b> . . . . .        | <b>12</b> |
| <b>9</b>  | <b>Legal information</b> . . . . .       | <b>13</b> |
| 9.1       | Data sheet status . . . . .              | 13        |
| 9.2       | Definitions . . . . .                    | 13        |
| 9.3       | Disclaimers . . . . .                    | 13        |
| 9.4       | Trademarks . . . . .                     | 13        |
| <b>10</b> | <b>Contact information</b> . . . . .     | <b>13</b> |